



THE INSTITUTION OF ENGINEERS, MALAYSIA

Bangunan Ingenieur, Lots 60 & 62, Jalan 52/4, P.O. Box 223, Jalan Sultan, 46720 Petaling Jaya

Tel: 03-7968 4001/4002 Fax: 03-7957 7678 E-mail: sec@iem.org.my

Homepage: <http://www.iem.org.my>

PROFESSIONAL INTERVIEW WORKSHOP ON ENHANCED PI PROCESS

(Organised by the Ad Hoc Committee on Revised PI Process & Professional Interview Board, IEM)

Date : 9 April 2016 (Saturday)
Time : 9.00 am to 1.00 pm (Refreshment will be served at 8.30am)
Venue : C & S Lecture Room and TUS Lecture Room,
 2nd Floor, Wisma IEM
Speaker : Ir. Lee Boon Chong
 Ir. Tu Yong Eng
 Ir. Noor Hisham bin Yahaya

BEM Approved
 PDP Hours: 2
 IEM15/PDP/016/T

REGISTRATION FEE (inclusive of GST)		
Grade	Normal	Online
IEM member	RM32	RM22
Non IEM member	RM130	RM106



Synopsis

The revised PI process is not a new PI process. It is the **revised version** of the existing PI Process in that the structure of the existing PI Process remains the same, consisting of:

- Part 1: Documentary review of competency evidence to assess Applicant's eligibility and readiness for Professional Interview.
- Part 2: In-person assessment of Candidate that consists of face-to-face oral interview as well as writing two essays
- The revision aims to **enhance** existing PI Process, where appropriate.
 - Current Application Form
 - Training and Experienced Report
 - Assessment Method

PERSONAL DATA PROTECTION ACT

I have read and understood the IEM's Personal Data Protection Notice published on IEM's website at <http://www.myiem.org.my> and I agree to IEM's use and processing of my personal data as set out in the said notice.

Reply Slip (Fax to: 03- 7957 7678)

Chairman
Professional Interview Board
The Institution of Engineers, Malaysia

PROFESSIONAL INTERVIEW WORKSHOP ON ENHANCED PI PROCESS

I wish to participate in the Professional Interview workshop on **9 April 2016 (Saturday)**. I enclose herewith a cheque No./Cash..... for the amount of..... as my commitment fee for the workshop.

Name of Member: M'ship No:
 Email: Grade:
 Company's Name: Tel (H/P):

.....
Signature **Date**

(Photostat copies are acceptable)